

# SN54ABT16646, SN74ABT16646 16-BIT BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

SCBS212D – JUNE 1992 – REVISED JULY 1999

- **Members of the Texas Instruments Widebus™ Family**
- **State-of-the-Art EPIC-II B™ BiCMOS Design Significantly Reduces Power Dissipation**
- **Latch-Up Performance Exceeds 500 mA Per JESD 17**
- **Typical  $V_{OLP}$  (Output Ground Bounce) < 1 V at  $V_{CC} = 5 V, T_A = 25^\circ C$**
- **Distributed  $V_{CC}$  and GND Pin Configuration Minimizes High-Speed Switching Noise**
- **Flow-Through Architecture Optimizes PCB Layout**
- **High-Drive Outputs ( $-32\text{-mA } I_{OH}, 64\text{-mA } I_{OL}$ )**
- **Package Options Include Plastic Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings**

## description

The 'ABT16646 devices consist of bus-transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers.

These devices can be used as two 8-bit transceivers or one 16-bit transceiver. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the 'ABT16646 devices.

Output-enable ( $\overline{OE}$ ) and direction-control (DIR) inputs are provided to control the transceiver functions. In the transceiver mode, data present at the high-impedance port may be stored in either register or in both. The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. The circuitry used for select control eliminates the typical decoding glitch that occurs in a multiplexer during the transition between stored and real-time data. The direction control (DIR) determines which bus receives data when  $\overline{OE}$  is low. In the isolation mode ( $\overline{OE}$  high), A data can be stored in one register and/or B data can be stored in the other register.

When an output function is disabled, the input function is still enabled and can be used to store and transmit data. Only one of the two buses, A or B, can be driven at a time.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

SN54ABT16646 ... WD PACKAGE  
SN74ABT16646 ... DGG OR DL PACKAGE  
(TOP VIEW)

1DIR	1	56	$\overline{1OE}$
1CLKAB	2	55	1CLKBA
1SAB	3	54	1SBA
GND	4	53	GND
1A1	5	52	1B1
1A2	6	51	1B2
$V_{CC}$	7	50	$V_{CC}$
1A3	8	49	1B3
1A4	9	48	1B4
1A5	10	47	1B5
GND	11	46	GND
1A6	12	45	1B6
1A7	13	44	1B7
1A8	14	43	1B8
2A1	15	42	2B1
2A2	16	41	2B2
2A3	17	40	2B3
GND	18	39	GND
2A4	19	38	2B4
2A5	20	37	2B5
2A6	21	36	2B6
$V_{CC}$	22	35	$V_{CC}$
2A7	23	34	2B7
2A8	24	33	2B8
GND	25	32	GND
2SAB	26	31	2SBA
2CLKAB	27	30	2CLKBA
2DIR	28	29	$\overline{2OE}$

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# SN54ABT16646, SN74ABT16646

## 16-BIT BUS TRANSCEIVERS AND REGISTERS

### WITH 3-STATE OUTPUTS

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#### description (continued)

The SN54ABT16646 is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ .  
 The SN74ABT16646 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

FUNCTION TABLE

INPUTS						DATA I/O†		OPERATION OR FUNCTION
$\overline{\text{OE}}$	DIR	CLKAB	CLKBA	SAB	SBA	A1–A8	B1–B8	
X	X	↑	X	X	X	Input	Unspecified	Store A, B unspecified†
X	X	X	↑	X	X	Unspecified	Input	Store B, A unspecified†
H	X	↑	↑	X	X	Input	Input	Store A and B data
H	X	H or L	H or L	X	X	Input disabled	Input disabled	Isolation, hold storage
L	L	X	X	X	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	X	H	Output	Input	Stored B data to A bus
L	H	X	X	L	X	Input	Output	Real-time A data to B Bus
L	H	H or L	X	H	X	Input	Output	Stored A data to bus

† The data-output functions can be enabled or disabled by various signals at  $\overline{\text{OE}}$  or DIR. Data-input functions always are enabled, i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

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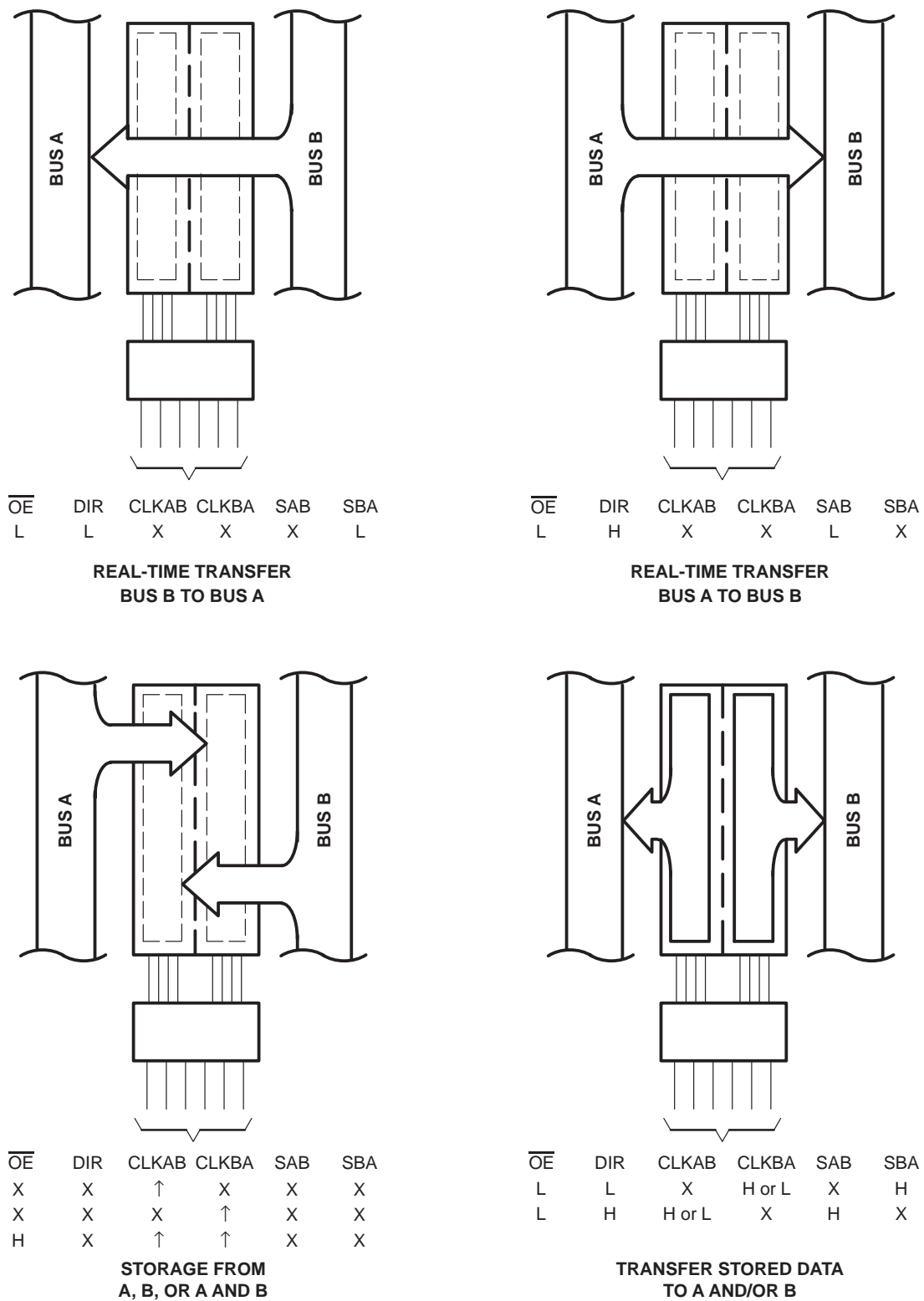
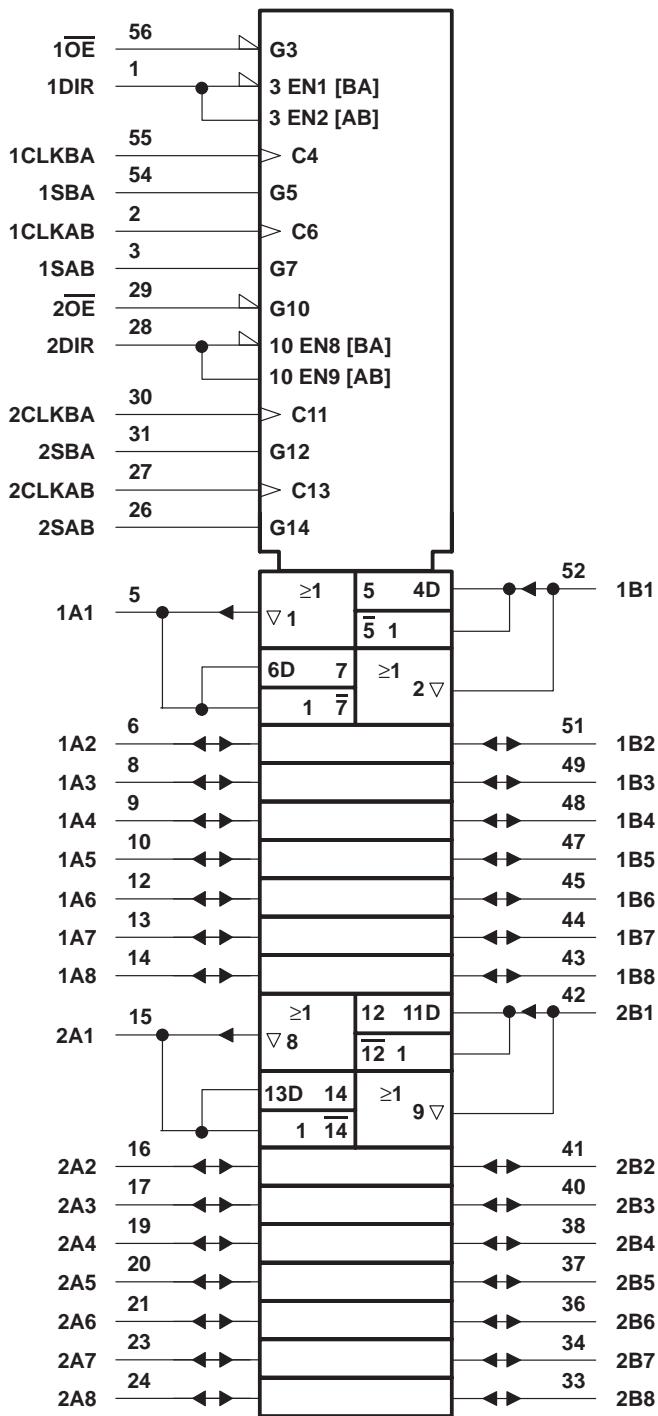


Figure 1. Bus-Management Functions

# SN54ABT16646, SN74ABT16646 16-BIT BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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## logic symbol†

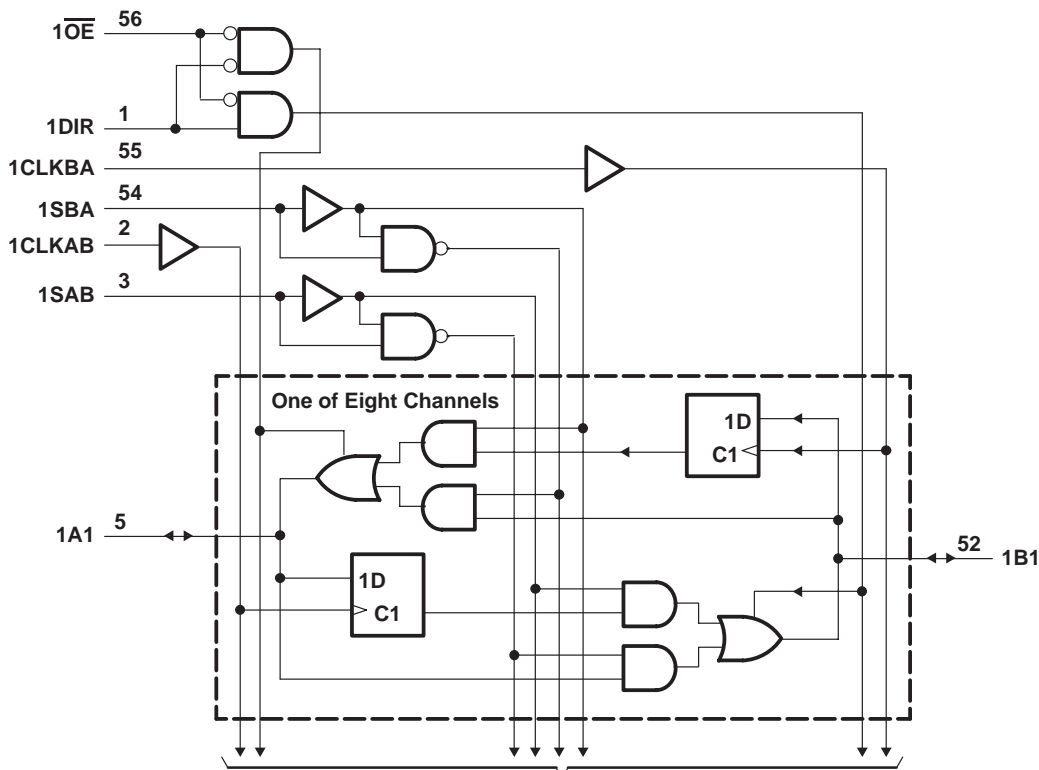


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

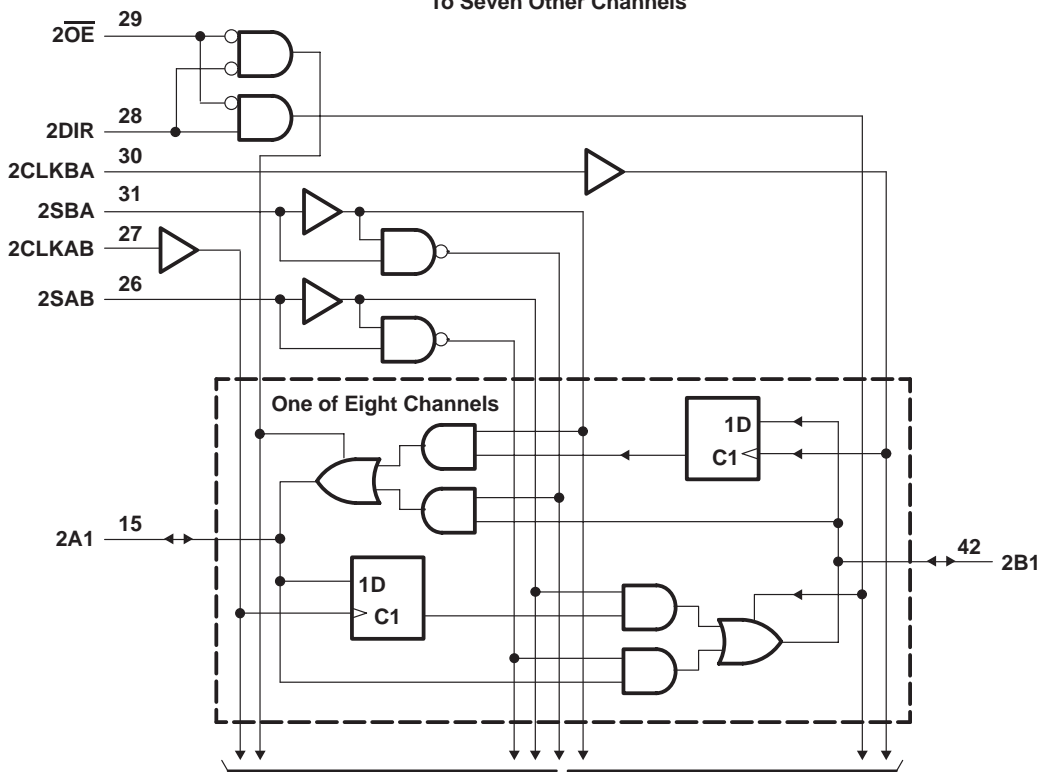
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logic diagram (positive logic)



To Seven Other Channels



To Seven Other Channels

# SN54ABT16646, SN74ABT16646 16-BIT BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, $V_{CC}$	–0.5 V to 7 V
Input voltage range, $V_I$ (except I/O ports) (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high or power-off state, $V_O$	–0.5 V to 5.5 V
Current into any output in the low state, $I_O$ : SN54ABT16646	96 mA
SN74ABT16646	128 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	–50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): DGG package	81°C/W
DL package	74°C/W
Storage temperature range, $T_{stg}$	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51.

## recommended operating conditions (see Note 3)

	SN54ABT16646		SN74ABT16646		UNIT
	MIN	MAX	MIN	MAX	
$V_{CC}$ Supply voltage	4.5	5.5	4.5	5.5	V
$V_{IH}$ High-level input voltage	2		2		V
$V_{IL}$ Low-level input voltage		0.8		0.8	V
$V_I$ Input voltage	0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$ High-level output current		–24		–32	mA
$I_{OL}$ Low-level output current		48		64	mA
$\Delta t/\Delta v$ Input transition rise or fall rate		10		10	ns/V
$T_A$ Operating free-air temperature	–55	125	–40	85	°C

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

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**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	$T_A = 25^\circ\text{C}$			SN54ABT16646		SN74ABT16646		UNIT		
		MIN	TYP†	MAX	MIN	MAX	MIN	MAX			
$V_{IK}$	$V_{CC} = 4.5\text{ V}$ , $I_I = -18\text{ mA}$			-1.2		-1.2		-1.2	V		
$V_{OH}$	$V_{CC} = 4.5\text{ V}$ , $I_{OH} = -3\text{ mA}$	2.5			2.5			2.5	V		
	$V_{CC} = 5\text{ V}$ , $I_{OH} = -3\text{ mA}$	3			3			3			
	$V_{CC} = 4.5\text{ V}$				2			2			
$V_{OL}$	$V_{CC} = 4.5\text{ V}$	$I_{OL} = 48\text{ mA}$		0.55		0.55			V		
		$I_{OL} = 64\text{ mA}$		0.55*				0.55			
$V_{hys}$			100						mV		
$I_I$	Control inputs	$V_{CC} = 5.5\text{ V}$ , $V_I = V_{CC}$ or GND			$\pm 1$			$\pm 1$		$\mu\text{A}$	
	A or B ports										$\pm 20$
$I_{OZH}^\ddagger$	$V_{CC} = 5.5\text{ V}$ , $V_O = 2.7\text{ V}$			10		10		10	$\mu\text{A}$		
$I_{OZL}^\ddagger$	$V_{CC} = 5.5\text{ V}$ , $V_O = 0.5\text{ V}$			-10		-10		-10	$\mu\text{A}$		
$I_{off}$	$V_{CC} = 0$ , $V_I$ or $V_O \leq 4.5\text{ V}$			$\pm 100$				$\pm 100$	$\mu\text{A}$		
$I_{CEX}$	$V_{CC} = 5.5\text{ V}$ , $V_O = 5.5\text{ V}$	Outputs high			50			50	50	$\mu\text{A}$	
$I_O^\S$	$V_{CC} = 5.5\text{ V}$ , $V_O = 2.5\text{ V}$	-50	-100	-180	-50	-180	-50	-180	mA		
$I_{CC}$	A or B ports	$V_{CC} = 5.5\text{ V}$ , $I_O = 0$ , $V_I = V_{CC}$ or GND			Outputs high			2	2	2	mA
					Outputs low			32	32	32	
					Outputs disabled			2	2	2	
$\Delta I_{CC}^\parallel$	Data inputs	$V_{CC} = 5.5\text{ V}$ , One input at 3.4 V, Other inputs at $V_{CC}$ or GND			Outputs enabled			50	50	50	$\mu\text{A}$
					Outputs disabled			50	50	50	
	Control inputs	$V_{CC} = 5.5\text{ V}$ , One input at 3.4 V, Other inputs at $V_{CC}$ or GND			50			50	50		
$C_i$	Control inputs	$V_I = 2.5\text{ V}$ or $0.5\text{ V}$			4					pF	
$C_{io}$	A or B ports	$V_O = 2.5\text{ V}$ or $0.5\text{ V}$			8					pF	

\* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at  $V_{CC} = 5\text{ V}$ .

‡ The parameters  $I_{OZH}$  and  $I_{OZL}$  include the input leakage current.

§ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

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**timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 2)**

	SN54ABT16646				UNIT
	V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C		MIN	MAX	
	MIN	MAX			
f <sub>clock</sub> Clock frequency	125		125		MHz
t <sub>w</sub> Pulse duration, CLK high or low	4.3		4.3		ns
t <sub>su</sub> Setup time, A or B before CLKAB↑ or CLKBA↑	3.5		4		ns
t <sub>h</sub> Hold time, A or B after CLKAB↑ or CLKBA↑	0.5		0.5		ns

**timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 2)**

	SN74ABT16646				UNIT
	V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C		MIN	MAX	
	MIN	MAX			
f <sub>clock</sub> Clock frequency	125		125		MHz
t <sub>w</sub> Pulse duration, CLK high or low	4.3		4.3		ns
t <sub>su</sub> Setup time, A or B before CLKAB↑ or CLKBA↑	3		3		ns
t <sub>h</sub> Hold time, A or B after CLKAB↑ or CLKBA↑	0		0		ns



# SN54ABT16646, SN74ABT16646 16-BIT BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54ABT16646					UNIT
			$V_{CC} = 5$ V, $T_A = 25^\circ$ C			MIN	MAX	
			MIN	TYP	MAX			
$f_{max}$			125			125	MHz	
$t_{PLH}$	CLKBA or CLKAB	A or B	1.5	3.1	4	1	5	ns
$t_{PHL}$			1.5	3.2	4.1	1	5	
$t_{PLH}$	A or B	B or A	1	2.3	3.2	0.6	4	ns
$t_{PHL}$			1	3	4.1	0.6	4.9	
$t_{PLH}$	SAB or SBA†	B or A	1	2.9	4.3	0.6	5.3	ns
$t_{PHL}$			1	3.1	4.3	0.6	5.3	
$t_{PZH}$	$\overline{OE}$	A or B	1	3.4	4.6	0.6	5.9	ns
$t_{PZL}$			1.5	3.5	5.3	1	6	
$t_{PHZ}$	$\overline{OE}$	A or B	1.5	3.9	5.6	1	6.4	ns
$t_{PLZ}$			1.5	3.1	4.4	1	4.7	
$t_{PZH}$	DIR	A or B	1	3.2	4.5	0.6	5.8	ns
$t_{PZL}$			1.5	3.4	5.1	1	6.7	
$t_{PHZ}$	DIR	A or B	2	4.2	5.9	1.2	7.1	ns
$t_{PLZ}$			1.5	3.6	5.1	1	6.2	

† These parameters are measured with the internal output state of the storage register opposite that of the bus input.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $C_L = 50$  pF (unless otherwise noted) (see Figure 2)

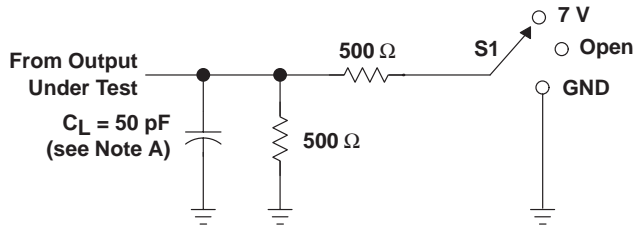
PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN74ABT16646					UNIT
			$V_{CC} = 5$ V, $T_A = 25^\circ$ C			MIN	MAX	
			MIN	TYP	MAX			
$f_{max}$			125			125	MHz	
$t_{PLH}$	CLKBA or CLKAB	A or B	1.5	3.1	4	1.5	4.9	ns
$t_{PHL}$			1.5	3.2	4.1	1.5	4.7	
$t_{PLH}$	A or B	B or A	1	2.3	3.2	1	3.9	ns
$t_{PHL}$			1	3	4.1	1	4.6	
$t_{PLH}$	SAB or SBA†	B or A	1	2.9	4.3	1	5	ns
$t_{PHL}$			1	3.1	4.3	1	5	
$t_{PZH}$	$\overline{OE}$	A or B	1	3.4	4.6	1	5.5	ns
$t_{PZL}$			1.5	3.5	4.9	1.5	5.7	
$t_{PHZ}$	$\overline{OE}$	A or B	1.5	3.9	4.9	1.5	5.4	ns
$t_{PLZ}$			1.5	3.1	4.1	1.5	4.5	
$t_{PZH}$	DIR	A or B	1	3.2	4.5	1	5.4	ns
$t_{PZL}$			1.5	3.4	4.8	1.5	5.6	
$t_{PHZ}$	DIR	A or B	2	4.2	5.7	2	6.7	ns
$t_{PLZ}$			1.5	3.6	5.1	1.5	5.9	

† These parameters are measured with the internal output state of the storage register opposite that of the bus input.

# SN54ABT16646, SN74ABT16646 16-BIT BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

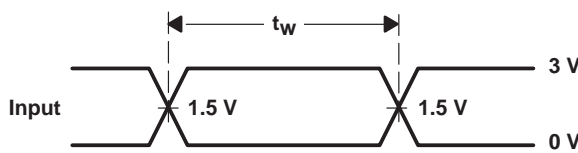
SCBS212D – JUNE 1992 – REVISED JULY 1999

## PARAMETER MEASUREMENT INFORMATION

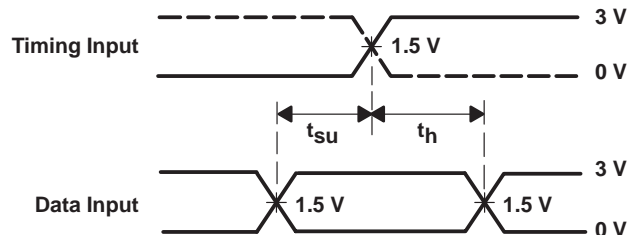


LOAD CIRCUIT

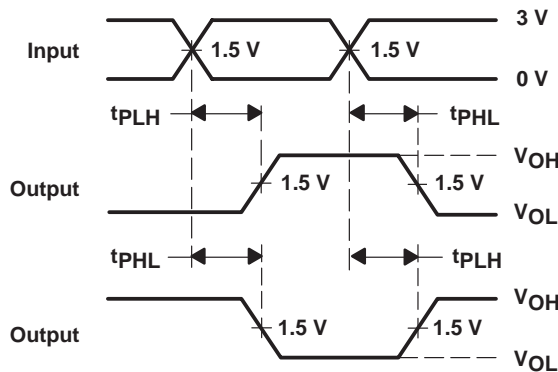
TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	7 V
$t_{PHZ}/t_{PZH}$	Open



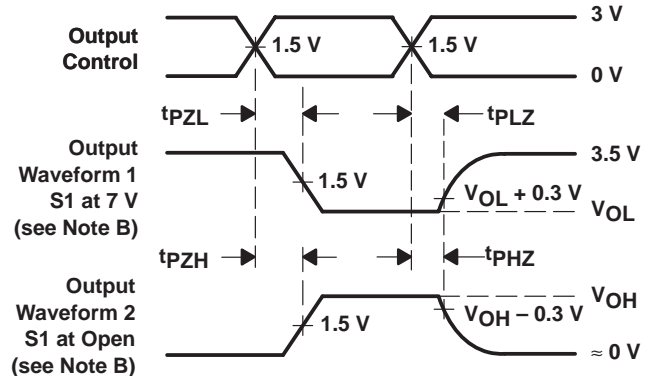
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - The outputs are measured one at a time with one transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms

## PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
5962-9450201QXA	ACTIVE	CFP	WD	56	1	TBD	Call TI	Level-NC-NC-NC
74ABT16646DGGRE4	ACTIVE	TSSOP	DGG	56	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16646DGGR	ACTIVE	TSSOP	DGG	56	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16646DL	ACTIVE	SSOP	DL	56	20	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16646DLR	ACTIVE	SSOP	DL	56	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16646DLRG4	ACTIVE	SSOP	DL	56	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54ABT16646WD	ACTIVE	CFP	WD	56	1	TBD	Call TI	Level-NC-NC-NC

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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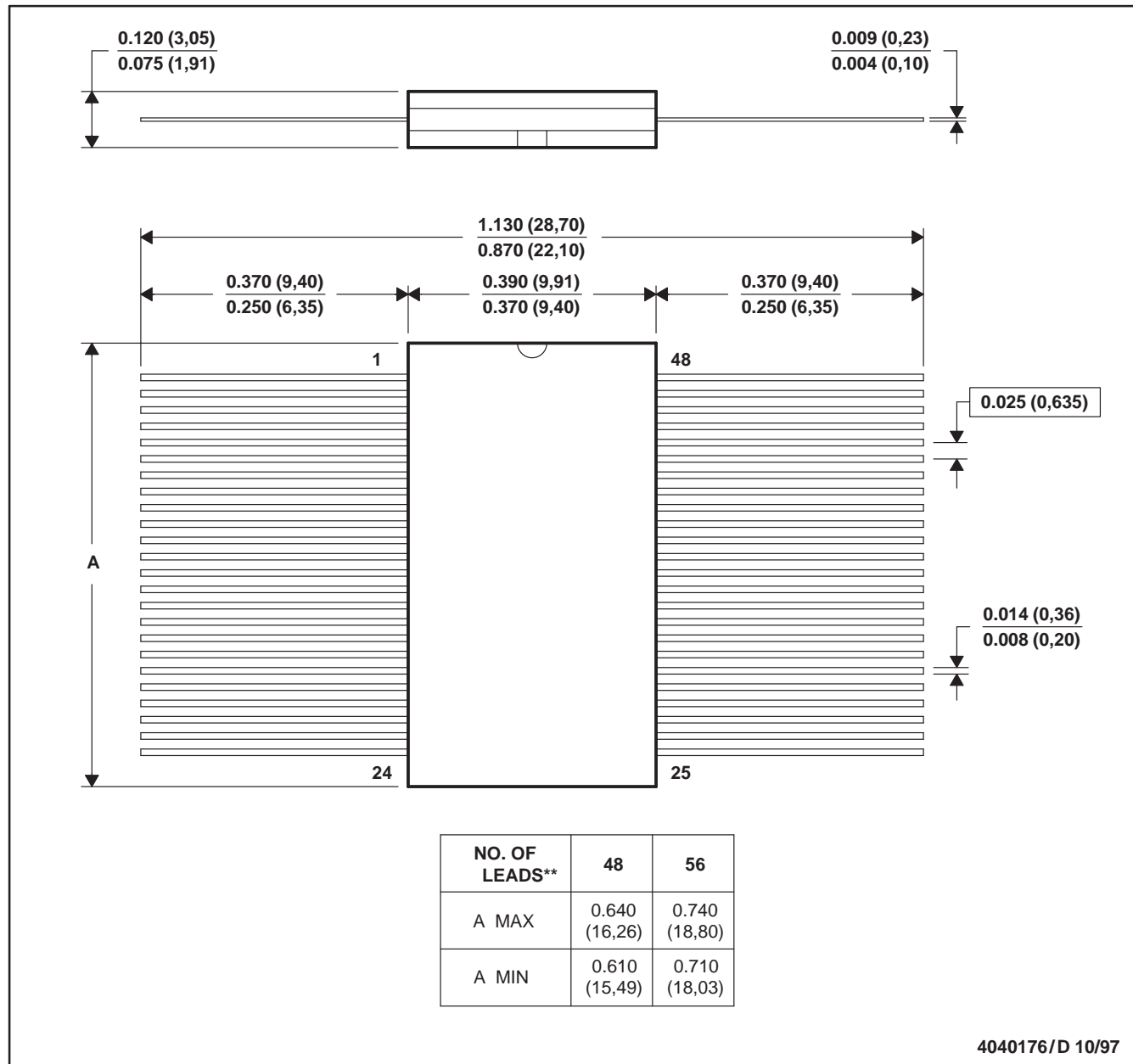
# MECHANICAL DATA

MCFP010B – JANUARY 1995 – REVISED NOVEMBER 1997

**WD (R-GDFP-F\*\*)**

**CERAMIC DUAL FLATPACK**

48 LEADS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only
  - E. Falls within MIL STD 1835: GDFP1-F48 and JEDEC MO-146AA  
GDFP1-F56 and JEDEC MO-146AB

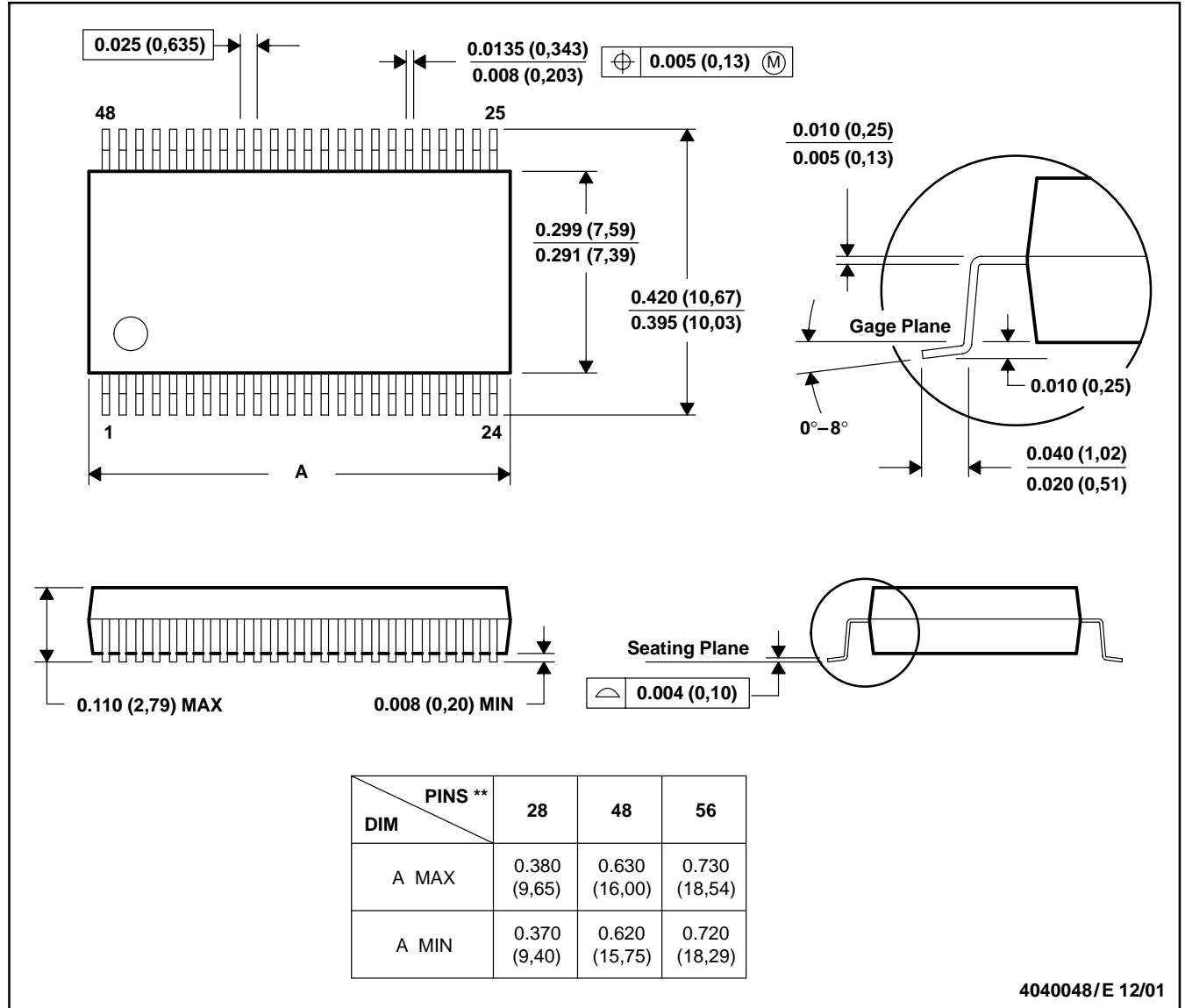
# MECHANICAL DATA

MSS0001C – JANUARY 1995 – REVISED DECEMBER 2001

**DL (R-PDSO-G\*\*)**

**PLASTIC SMALL-OUTLINE PACKAGE**

48 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MO-118

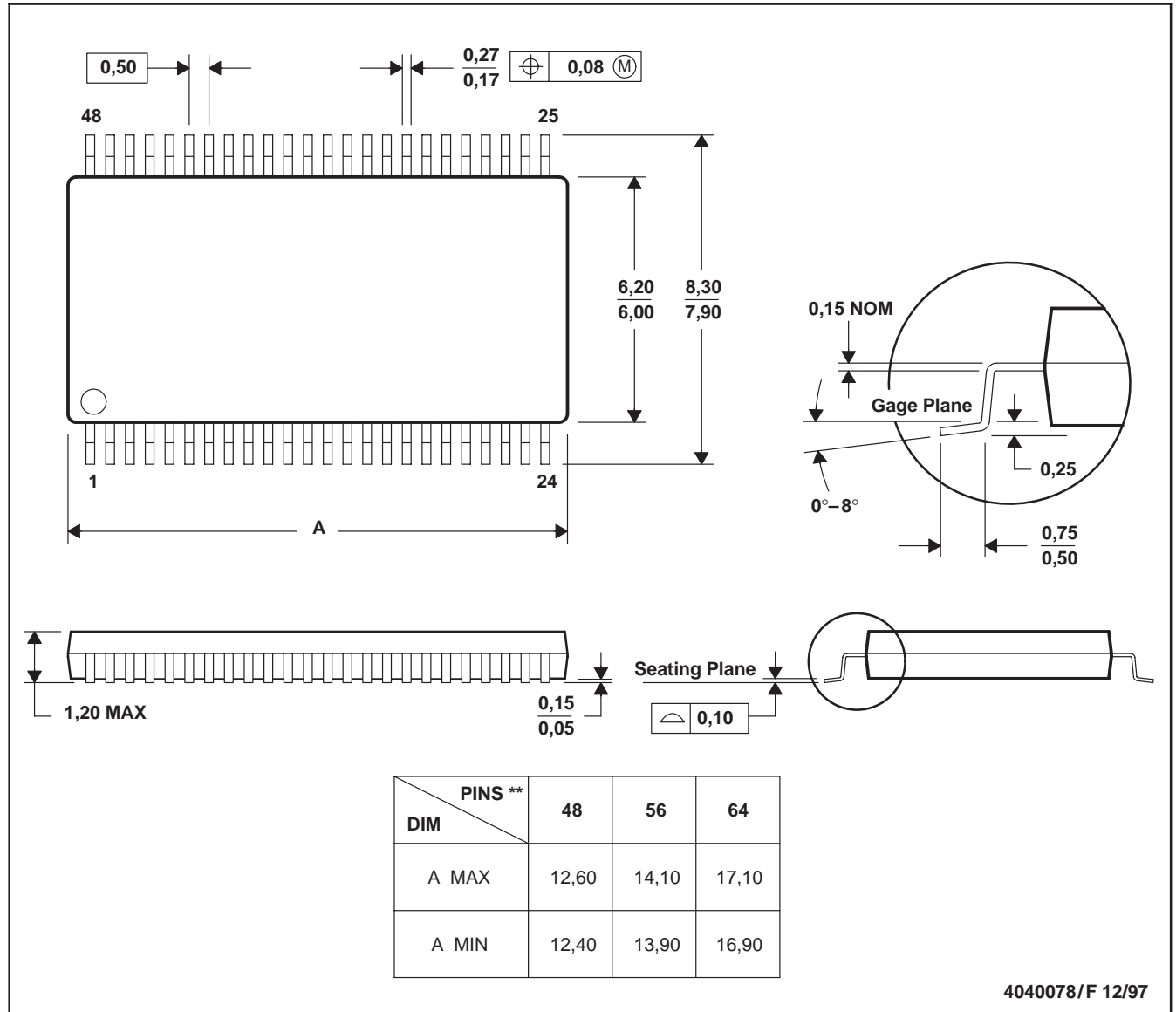
# MECHANICAL DATA

MTSS003D – JANUARY 1995 – REVISED JANUARY 1998

DGG (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold protrusion not to exceed 0,15.
  - Falls within JEDEC MO-153

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